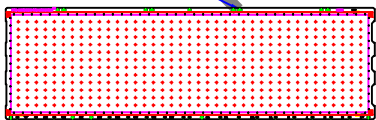


框架传送方向 (装片):

L/F Direction (D/A): 椭圆孔



注意: 基岛全镀银

实物图:

Chip photo:

特殊说明 Special Instructions:

DFN8L(5×6×0.75-P1.27)D(183×96mil<sup>2</sup>)(1 block)  
(4660×2450um<sup>2</sup>)